sigPOD offers a range of feature checks for crimp analysis, allowing device manufacturers to increase efficiency, drastically lower scrap rates, and maintain robust historical test data.

The Sciemetric sigPOD Crimp application offers a wide range of feature checks for crimp analysis. This includes 100% monitoring of crimp or staking operations, where up to 4 crimps can be simultaneously tested. Real time pass fail indication provides immediate feedback while full serialized traceability including test waveforms and other historical data are available in production.

Using the sigPOD crimp application, costly downstream waste is eliminated as defects are detected at the source of the operation. Efficiency is drastically increased with lean in process testing, where up to 4 crimps can be simultaneously monitored. Once in production, the sigPOD platform, in conjunction with QualityWorX data analytics software, acts as a process examiner to ensure continued quality assurance and traceability.

Benefits

- 100% monitoring of crimp or staking operation
- Defects detected upstream
- Sequential or simultaneous monitoring of up to 4 crimps
- Signature analysis and full reporting
- Full serialized traceability including test waveforms
- Real time pass fail indication
- Integral SPC analysis for multiple feature checks